



MAS-FIN-153

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450:

By: 

Date: October 17, 2003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applic. No. : 10/090,289 Confirmation No. 6619
Applicant : Johann Winderl
Filed : March 4, 2002
TC/A.U. : 2827
Examiner : Luan C. Thai
Title : Electric Component with Stacked Semiconductor Chips

Docket No. : MAS-FIN-153
Customer No. : 24131

Hon. Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

S i r :

In response to the Office action dated July 25, 2003, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 8 of this paper.

An **Appendix** including a certified English translation of German Priority Application 101 10 203.8 is attached following page 13 of this paper.